

EcoGreen[™]

Innovative **Technology** for a **Connected** World

Environmentally Friendly Fabric-Over-Foam Shielding Gaskets



ENVIRONMENTALLY FRIENDLY, HALOGEN-FREE, FLAME RETARDANT EMI SHIELDING SOLUTIONS

Laird Technologies is pleased to introduce the next generation in RoHS-compliant EMI shielding technology.

While Laird Technologies' Fabric-Over-Foam EMI gaskets are RoHS compliant, we are proactively strengthening our compliancy by engineering halogen-free EcoGreenTM shields.

Not only are the patented EcoGreenTM shields environmentally friendly, they offer high EMI shielding effectiveness, extremely low compression forces, abrasion-resistant metallized fabrics, large service temperature ranges, and multiple profile/gasket options.

Laird Technologies' shields are flame retardant and pass the stringent UL94-V0 burn test.

KEY FEATURES

- Halogen-free; meets IEC 61249-2-21 standard
- Profiles and I/O gaskets are available with pressure sensitive adhesive (PSA) tape
- Profiles can be cut to specified lengths, kiss-cut release liner or mitered to form frame configurations
- Shielding effectiveness of > 100 dB
- Extremely low compression force allows the use of lighter weight materials with less fastening and hinge hardware
- Low surface resistivity as low as < 0.07 ohms/square provides improved conductivity (ASTM F390*)
- Service temperature range from - 40°F to 158°F (- 40°C to 70°C)

APPLICATIONS

- Computer servers
- Desktop computers
- Digital cameras
- Internal/external hard drives
- Liquid Crystal Displays (LCDs)
- Medical equipment
- Notebook computers
- Plasma Display Panels (PDPs)
- Printers
- Set-top boxes
- Telecommunications enclosure cabinets

AGENCY APPROVALS

- UL designation V0 041
- UL File #OCDT2.E170327
- UL Yellow Card (found at www.ul.com)

*Modified

global solutions: local support ™

USA: +1.866.928.8181 Europe: +49.8031.2460.0 Asia: +86.755.2714.1166





EcoGreen[™]

Innovative **Technology** for a **Connected** World

Environmentally Friendly Fabric-Over-Foam Shielding Gaskets

FABRIC

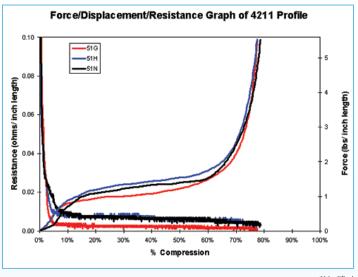
PRODUCT NUMBER	FABRIC TYPE	METAL COATING	CONDUCTIVITY	APPLICATION	TEST METHOD
51G	Ripstop	Ni/Cu	<0.07 ohms/square	I/O or Profile Gaskets	Flame retardant, high abrasion resistance
51H	Taffeta	Ni/Cu	<0.07 ohms/square	I/O or Profile Gaskets	Flame retardant, abrasion resistant
51N	Knit Mesh	Ni/Cu	<0.10 ohms/square	I/O or Profile Gaskets	Low cost, flame retardant

FOAM

FOAM TYPE	COMPRESSION SET (ASTM D 3574*)	COLOR	APPLICATION	BENEFITS
Urethane (Polyester)	5 - 10%	Charcoal	I/O or Profile Gaskets	Simple, moderate shapes, low compression force / compression set, flame retardant

PRESSURE SENSITIVE ADHESIVE

PRESSURE SENSITIVE ADHESIVE	THICKNESS	BENEFITS	
Acrylic Non-conductive	.005"	High peel strength, temperature resistant	
Acrylic Conductive	.004"	Electrically conductive in Z-axis direction	



*Modified

global solutions: local support ™

USA: +1.866.928.8181 Europe: +49.8031.2460.0 Asia: +86.755.2714.1166



EMI-DS-ECOGREEN 1209

Any information furnished by Laird Technologies, Inc. and its agents is believed to be accurate and reliable. All specifications are subject to change without notice. Responsibility for the use and application of Laird Technologies materials is produced by the fitness, merchantability or suitability of any Laird Technologies materials or products for any specific or general uses. Laird Technologies makes no warranties as to the fitness, merchantability or suitability of any Laird Technologies products for any specific or general uses. Laird Technologies shall not be liable for incidental or consequential damages of any kind. All Laird Technologies products are sold pursuant to the Laird Technologies. Ferms and Conditions of sale in effect from time to time, a copy of which will be furnished upon request. © Copyright 2009 Laird Technologies, Inc. All Rights Reserved. Laird, Laird Technologies, the Laird Technologies Logo, and other marks are trade marks or registered trade marks of Laird Technologies. Inc. or an affiliate company thereof. Other product or service names may be the property of third parties. Nothing herein provides a license under any Laird Technologies or any third party intellectual property rights.